

Statement of Compliance

Requested Part

08 June 2023	1-15461	05-0	(Part 1 of 1)
	TE Internal Number:	1-1546105-0	
	Product Description:	10 POS 5.08MM LH PLUG BLCK	
	Part Status:	Active	
	Mil-Spec Certified:	No	
	EU RoHS Directive 2011/65/EU:	Compliant with Exemptions 6(c) - Pb-Alloy in Copper	

This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

EU ELV Directive: 2000/53/EC	Compliant with Exemptions 3 - Lead in copper alloy containing up to 4% lead by weight.
China RoHS 2 Directive: MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation: (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JUL 2019 (201) Does not contain REACH SVHC
Halogen Content:	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability Code:	Not applicable for solder process capability

TE Connectivity Corporation

1050 Westlakes Drive

Berwyn, PA 19312

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Restricted Materials Above Threshold

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中国电子电气产品中有害物质的名称及含量

China EEP Hazardous Substance Information

部件名称		有害物质 Hazardous Substance						
(Component Name)								
1-1546105-0	铅	汞	镉	六价铬	多溴联苯	多溴二苯酸		
	(Pb)	(Hg)	(Cd)	(Cr6)	(PBB)	(PBDE)		
连接器系统	x	0	0	0	0	0		
(Connector Systems)								
Indicates that the	e concentration c	of the hazardou	us substance in					
Indicates that the below the releva	e concentration c nt threshold of th	of the hazardou ne GB/T 26572	us substance in standard.	n all homogen	eous materials	of the part is		
Indicates that the below the releva X: 表示该有害物质:	e concentration c nt threshold of th 至少在该部件的身	of the hazardou ne GB/T 26572 其一均质材料中	us substance ir standard. 的含量超出GE	n all homogen 3/T 26572标准	eous materials 规定的限量要习	of the part is 求。		
Indicates that the below the releva X: 表示该有害物质: Indicates that the	e concentration c nt threshold of th 至少在该部件的事 e concentration c	of the hazardou he GB/T 26572 其一均质材料中 of the hazardou	us substance in standard. 的含量超出GE us substance in	n all homogen 3/T 26572标准 n at least one	eous materials 规定的限量要习	of the part is 求。		
Indicates that the below the releva X: 表示该有害物质:	e concentration c nt threshold of th 至少在该部件的事 e concentration c	of the hazardou he GB/T 26572 其一均质材料中 of the hazardou	us substance in standard. 的含量超出GE us substance in	n all homogen 3/T 26572标准 n at least one	eous materials 规定的限量要习	of the part is 求。		
Indicates that the below the releva X: 表示该有害物质: Indicates that the part is above the	e concentration c nt threshold of th 至少在该部件的事 e concentration c	of the hazardou he GB/T 26572 其一均质材料中 of the hazardou old of the GB/T	us substance in standard. 的含量超出GE us substance in 26572 standa	n all homogen B/T 26572标准 n at least one ard.	eous materials 规定的限量要素 homogeneous	of the part is 求。		

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